Spread Spectrum Clock Generator

MB88155

■ DESCRIPTION

MB88155 is a clock generator for EMI (Electro Magnetic Interference) reduction. The peak of unnecessary radiation noise (EMI) can be attenuated by making the oscillation frequency slightly modulate periodically with the internal modulator. For modulation, the MB88155 supports both center-spreading and down-spreading. It has a non-modulated output pin (REFOUT) as well as a modulated output pin (CKOUT).

■ FEATURES

• Input frequency: 12.5 MHz to 50 MHz (Multiplied by 1)

12.5 MHz to 20 MHz (Multiplied by 4)

• Output frequency: CKOUT 12.5 MHz to 80 MHz

REFOUT The same as input frequency (not multiplied)

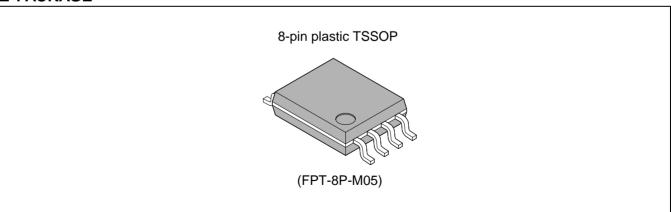
- Modulation rate : \pm 0.5%, \pm 1.0% (center spread) , 1.0%, 2.0% (Down spread)
- Equipped with oscillation circuit: range of oscillation 12.5 MHz to 40 MHz (Fundamental oscillation)

40 MHz to 48 MHz (3rd overtone)

• Modulation clock output Duty: 40% to 60%

(Continued)

■ PACKAGE





(Continued)

Modulation clock cycle – cycle jitter: MB88155-1xx
 MB88155-1xx
 MB88155-1xx
 MB88155-4xx
 MB88155-4xx
 12.5 MHz to 20 MHz
 less than 150 ps
 less than 100 ps
 less than 200 ps

• Low current consumption by CMOS process : 5 mA (24 MHz : Typ-sample, no load)

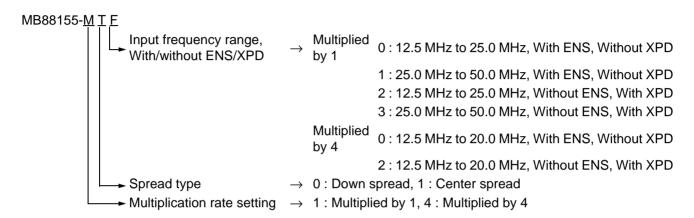
 \bullet Power supply voltage : 3.3 V \pm 0.3 V

• Operating temperature : - 40 °C to +85 °C

• Package: 8-pin plastic TSSOP

■ PRODUCT LINEUP

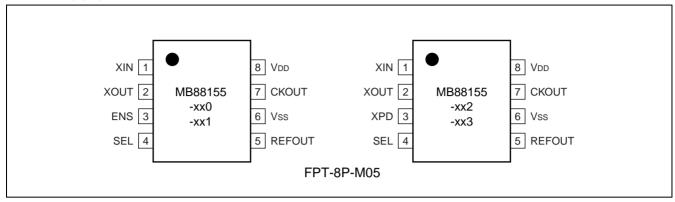
The MB88155 is available in different models : 2 models different in multiplier (\times 1 and \times 4) , 2 in modulation type (center-spreading and down-spreading) , 2 in input frequency range at a multiplier of 1 (12.5 MHz to 25 MHz and 25 MHz to 50 MHz) , and 1 in input frequency range at a multiplier of 4 (12.5 MHz to 20 MHz) . The MB88155 is also available in two versions : modulation-on/off selectable version (with ENS pin) and power-down function built-in version (with XPD pin) .



Line-up of MB88155

Product	Input frequency	Multiplication rate	Output frequency	Modulation type	Modulation enable pin	Power down pin
MB88155-100	12.5 MHz to 25 MHz				Yes	No
MB88155-101	25 MHz to 50 MHz			Down	163	INO
MB88155-102	12.5 MHz to 25 MHz		The same as input frequency	spread	No	Yes
MB88155-103	25 MHz to 50 MHz	Multiplied by 1			INO	168
MB88155-110	12.5 MHz to 25 MHz	Multiplied by 1		Center spread	Yes	No
MB88155-111	25 MHz to 50 MHz					INO
MB88155-112	12.5 MHz to 25 MHz				No	Yes
MB88155-113	25 MHz to 50 MHz					162
MB88155-400				Down	Yes	No
MB88155-402	40 5 MH I- 4- 00 MH I-	Multiplied by 4	50 MHz to	spread	No	Yes
MB88155-410	12.5 MHz to 20 MHz	iviuitiplied by 4	80 MHz	Center	Yes	No
MB88155-412				spread	No	Yes

■ PIN ASSIGNMENT



■ PIN DESCRIPTION

Pin name	I/O	Pin no.	Description
XIN	I	1	Connection pin of resonator/clock input pin
XOUT	0	2	Connection pin of resonator
ENS/XPD	I	3	Modulation enable pin/power down pin
SEL	ı	4	Modulation rate setting pin Down spread, SEL = "L" : Modulation rate -1.0% Down spread, SEL = "H" : Modulation rate -2.0% Down spread, SEL = "L" : Modulation rate $\pm 0.5\%$ Down spread, SEL = "H" : Modulation rate $\pm 1.0\%$
REFOUT	0	5	Non-modulated clock output pin This pin becomes to "L" at power-down.
Vss	_	6	GND Pin
CKOUT	0	7	Modulated clock output pin This pin becomes to "L" at power-down.
V _{DD}	_	8	Power supply voltage pin

■ I/O CIRCUIT TYPE

Pin	Circuit type	Remarks
SEL XPD		CMOS hysteresis input
ENS	50 kΩ 1	CMOS hysteresis input with pull-up resistor of 50 kΩ (Typ)
REFOUT		 CMOS output IoL = 3 mA "L" output at power-down

Pin	Circuit type	Remarks
CKOUT		 CMOS output IoL = 4 mA "L" output at power-down

For XIN pin and XOUT pin, refer to "■ OSCILLATION CIRCUIT".

■ HANDLING DEVICES

Preventing Latchup

A latchup can occur if, on this device, (a) a voltage higher than V_{DD} or a voltage lower than V_{SS} is applied to an input or output pin or (b) a voltage higher than the rating is applied between V_{DD} and V_{SS} . The latchup, if it occurs, significantly increases the power supply current and may cause thermal destruction of an element. When you use this device, be very careful not to exceed the maximum rating.

Handling unused pins

Do not leave an unused input pin open, since it may cause a malfunction. Handle by, using a pull-up or pull-down resistor.

Unused output pin should be opened.

The attention when the external clock is used

Input the clock to XIN pin, and XOUT pin should be opened when you use the external clock. Please pay attention so that an overshoot and an undershoot do not occur to an input clock of XIN pin.

Power supply pins

Please design connecting the power supply pin of this device by as low impedance as possible from the current supply source.

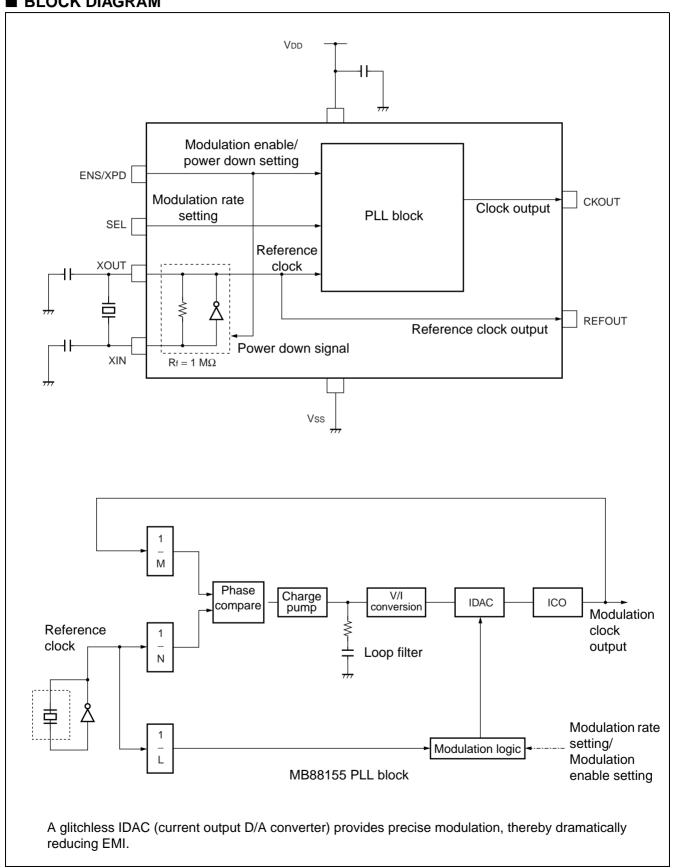
We recommend connecting electrolytic capacitor (about 10 μ F) and the ceramic capacitor (about 0.01 μ F) in parallel between Vss and V_{DD} near the device, as a bypass capacitor.

Oscillation circuit

Noise near the XIN and XOUT pins may cause the device to malfunction. Design printed circuit boards so that electric wiring of XIN or XOUT pin and the resonator do not intersect other wiring.

Design the printed circuit board that surrounds the XIN and XOUT pins with ground.

■ BLOCK DIAGRAM



■ PIN SETTING

The modulation clock requires stabilization wait time after the PIN setting is changed. For the modulation clock stabilization wait time, assure the maximum value for "Lock-up time" in the AC Characteristics list in "ELECTRICAL CHARACTERISTICS".

ENS modulation enable setting

ENS	Modulation				
L	No modulation	MB88155-xx0, xx1			
Н	Modulation	- IVID00133-XXU, XX1			

Note: Spectrum does not diffuse when "L" is set to ENS pin. MB88155-xx2, xx3 do not have ENS pin.

XPD power down

XPD	Status					
L	Power down status	MB88155-xx2, xx3				
Н	Operating status	WID00133-XX2, XX3				

Note: When setting "L" to XPD pin, it becomes power down mode (low power consumption mode). Both CKOUT and REFOUT of output pins are fixed to "L" output during power down. MB88155-xx0, xx1 do not have XPD pin.

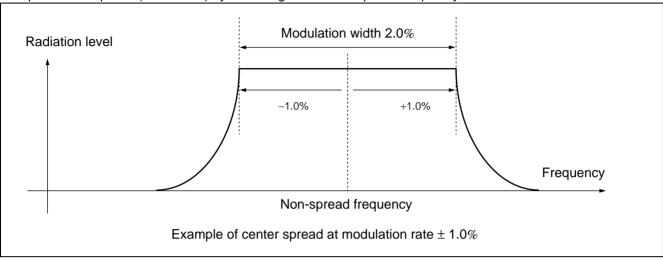
SEL modulation rate setting

SEL	Fred	Frequency				
1	± 0.5%	MB88155-x1x				
L	- 1.0%	MB88155-x0x				
Н	± 1.0%	MB88155-x1x				
	- 2.0%	MB88155-x0x				

Note: The modulation rate can be changed at the level of the pin.

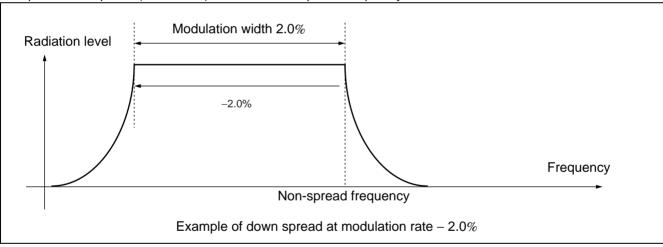
• Center spread

Spectrum is spread (modulated) by centering on the non-spread frequency.



• Down spread

Spectrum is spread (modulated) below the non-spread frequency.

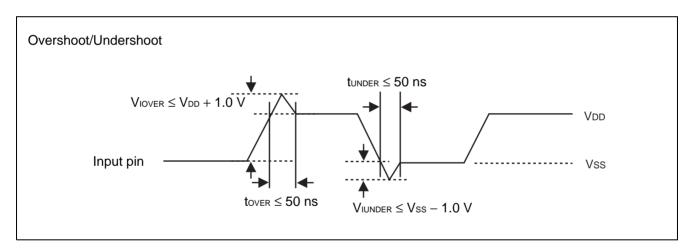


■ ABSOLUTE MAXIMUM RATINGS

Parameter	Cumbal	Rat	l lnit	
Parameter	Symbol	Min	Max	Unit
Power supply voltage*	V _{DD}	- 0.5	+ 4.0	V
Input voltage*	Vı	Vss - 0.5	V _{DD} + 0.5	V
Output voltage*	Vo	Vss - 0.5	V _{DD} + 0.5	V
Storage temperature	Tst	– 55	+ 125	°C
Operation junction temperature	TJ	- 40	+ 125	°C
Output current	lo	- 14	+ 14	mA
Overshoot	Viover	_	$V_{DD} + 1.0 \text{ (tover} \le 50 \text{ ns)}$	V
Undershoot	Viunder	Vss - 1.0 (tunder ≤ 50 ns)	_	V

^{* :} The parameter is based on $V_{SS} = 0.0 \text{ V}$.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.



■ RECOMMENDED OPERATING CONDITIONS

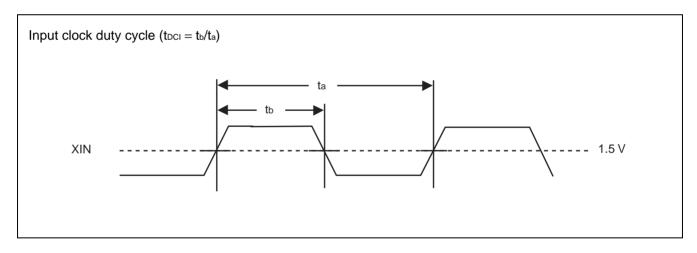
(Vss = 0.0 V)

Parameter	Symbol	Pin	Conditions	Value			
raiailletei	Syllibol	PIII	Conditions	Min	Тур	Max	Unit
Power supply voltage	V _{DD}	V_{DD}	_	3.0	3.3	3.6	V
"H" level input voltage	Vıн	XIN, SEL, ENS, XPD	_	$V_{DD} \times 0.8$	_	V _{DD} + 0.3	V
"L" level input voltage	VIL	XIN, SEL, ENS, XPD	_	Vss	_	$V_{DD} \times 0.2$	V
Input clock duty cycle	t DCI	XIN	12.5 MHz to 50 MHz	40	50	60	%
Operating temperature	Та	_	_	- 40	_	+ 85	°C

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

> Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

> No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.



■ ELECTRICAL CHARACTERISTICS

• DC Characteristics

(Ta = -40 °C to +85 °C, V_{DD} = 3.3 V \pm 0.3 V, V_{SS} = 0.0 V)

Donomotor	Crombal	Dia	Canditions		I I m i 4		
Parameter	Symbol	Pin	Conditions	Min	Тур	Max	Unit
Power supply current	Icc	V _{DD}	24 MHz output No load capacitance	_	5.0	7.0	mA
			At power-down	_	10	_	μΑ
	Vонс	CKOUT	"H" level output Іон = -4 mA	V _{DD} - 0.5		Vpp	
Output voltage	Vohr	REFOUT	"H" level output Іон = - 3 mA	7 VDD - U.5	_	V DD	V
	Volc	CKOUT	"L" level output IoL = 4 mA	Vss		0.4	>
	Volr	REFOUT	"L" level output IoL = 3 mA	- VSS	_		
Output impedance	Zoc	CKOUT	12.5 MHz to 80 MHz	_	45	_	Ω
Output impedance	Zor	REFOUT	12.5 MHz to 50 MHz	_	70		
		XIN, SEL, ENS/XPD	Ta = + 25 °C V _{DD} = V _I = 0.0 V f = 1 MHz	_		16	pF
Input pull-up resistor	Rpu	ENS	V _{IL} = 0.0 V	25	50	200	kΩ
		REFOUT	12.5 MHz to 50 MHz	_	_	15	
Load capacitance	C∟	CKOLIT	12.5 MHz to 50 MHz	_	_	15	pF
		CKOUT	50 MHz to 80 MHz	7			

AC Characteristics

 $(Ta = -40 \, ^{\circ}C \text{ to } + 85 \, ^{\circ}C, \, V_{DD} = 3.3 \, \text{V} \pm 0.3 \, \text{V}, \, \text{Vss} = 0.0 \, \text{V})$

Devementes	Cymahal	Din		1 00 0, 1		I Imit		
Parameter	Symbol	Pin	Conditions	Min	Тур	Max	Unit	
Oscillation	_	XIN,	Fundamental oscillation	12.5		40	N 41 1-	
frequency	fx	XOUT	3 rd overtone	40	_	48	MHz	
			MB88155 – 1x0, 1x2	12.5		25		
Input frequency	fin	XIN	MB88155 – 1x1, 1x3	25	_	50	MHz	
			MB88155 – 4xx	12.5	_	20		
			MB88155 – 1x0, 1x2	12.5	_	25		
		REFOUT	MB88155 – 1x1, 1x3	25	_	50		
Output framesanos	_		MB88155 – 4xx	12.5		20	N/I I-	
Output frequency	fоит		MB88155 – 1x0, 1x2	12.5	_	25	MHz	
		CKOUT	MB88155 – 1x1, 1x3	25	_	50		
			MB88155 – 4xx	50	_	80		
SRc		СКОИТ	Load capacitance 15 pF, 0.4 V to 2.4 V	0.4	_	4.0		
Output slew rate	SRR	REFOUT	Load capacitance 15 pF, 0.4 V to 2.4 V	0.3	_	2.0	V/ns	
Output clock	tocc	CKOUT	1.5 V reference level	40		60	07	
duty cycle	t _{DCR} REFOUT 1.5 V reference level		t _{DCI} - 10*1		t _{DCI} + 10*1	- %		
Modulation frequency	f _{MOD}	СКОИТ	Input frequency at 24 MHz	_	32.4	_	kHz	
Lock-up time*2	t LK	CKOUT	_		2	5	ms	
Cycle-cycle jitter			MB88155 – 1xx Input frequency 12.5 MHz to 20 MHz, No load capacitance, Ta = $+25$ °C, V _{DD} = 3.3 V, Standard deviation σ	_	_	150	ps	
	tuc CKOL	CKOUT	MB88155 $-$ 1xx Input frequency 20 MHz to 50 MHz, No load capacitance, Ta = $+$ 25 °C, V _{DD} = 3.3 V, Standard deviation σ	_	_	100	ps	
			MB88155 $-$ 4xx No load capacitance, Ta = $+$ 25 °C, V _{DD} = 3.3 V, Standard deviation σ	_	_	200	ps	

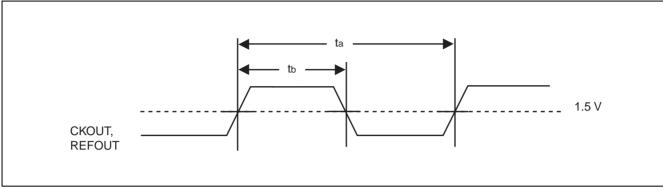
^{*1 :} Duty of the REFOUT output is guaranteed only for the following A and B because it depends on tool of input clock duty.

A. Resonator input: When resonator is connected with XIN and XOUT, and oscillates normally.

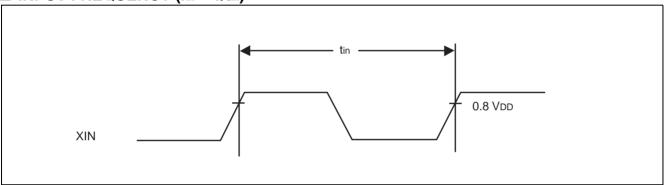
B. External clock input: The input level is Full-swing (Vss - VDD).

^{*2 :} The modulation clock requires stabilization wait time after the IC is turned on or released from power-down mode, or after SEL (modulation factor) or ENS (modulation on/off) setting is changed. For the modulation clock stabilization wait time, assure the maximum value for the lock-up time.

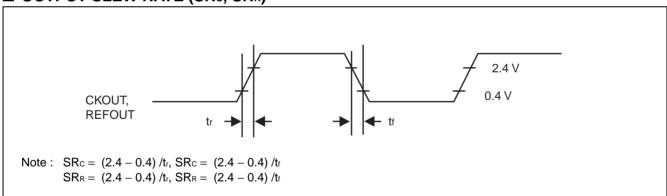
■ OUTPUT CLOCK DUTY CYCLE (tDCC, tDCR = tb/ta)



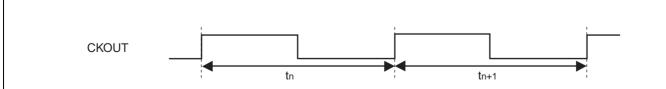
■ INPUT FREQUENCY (fin = 1/tin)



■ OUTPUT SLEW RATE (SRc, SRR)



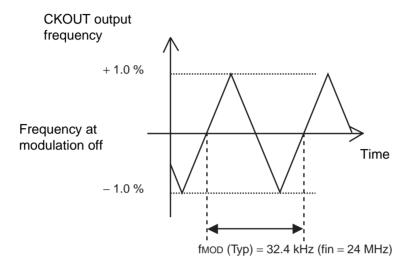
■ CYCLE-CYCLE JITTER $(t_{JC} = |t_n - t_n + 1|)$



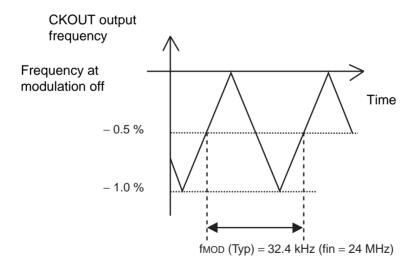
Note: Cycle-cycle jitter indicates the difference between a certain cycle and the immediately succeeding (or preceding) cycle.

■ MODULATION WAVEFORM

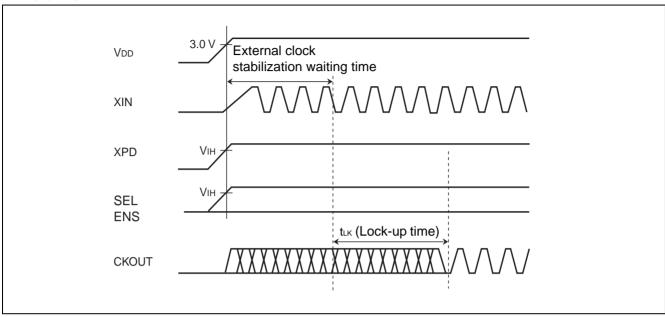
• Modulation rate $\pm 1.0\%$, example of center spread



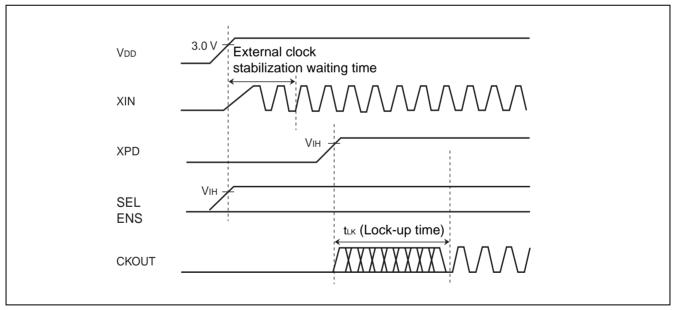
• Modulation rate - 1.0%, example of down spread



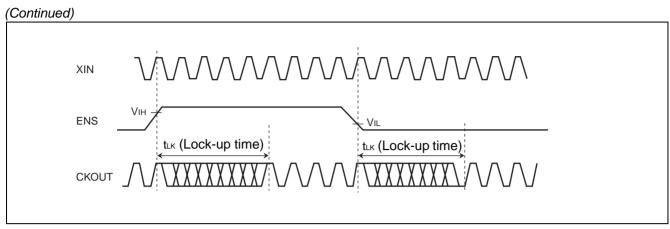
■ LOCK-UP TIME



If the XPD pin is fixed at the "H" level, the maximum time after the power is turned on until the set clock signal is output from CKOUT pin is (the stabilization wait time of input clock to XIN pin) + (the lock-up time "tlk"). For the input clock stabilization time, check the characteristics of the resonator or oscillator used.



If the XPD pin is used for power-down control, the set clock signal is output from the CKOUT pin at most the lock-up time "tlk" after the XPD pin goes "H" level.



If the ENS pin is used for modulation enable control during normal operation, the set clock signal is output from the CKOUT pin at most the lock-up time "tlk" after the level at the ENS pin is determined.

Note: The wait time for the clock signal output from the CKOUT pin to become stable is required after the IC is released from power-down mode by the XPD pin or after another pin's setting is changed. During the period until the output clock signal becomes stable, neither of the output frequency, output clock duty cycle, modulation period, and cycle-cycle jitter characteristic cannot be guaranteed. It is therefore advisable to take action, such as cancelling a device reset at the stage after the lock-up time has passed.

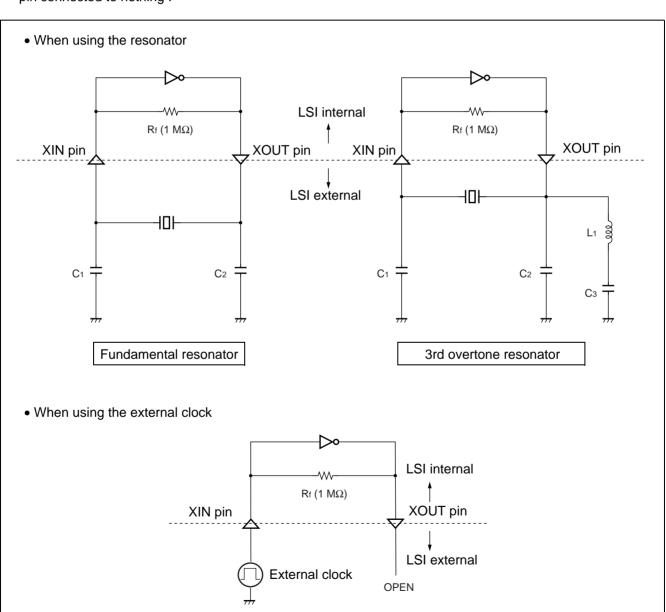
■ OSCILLATION CIRCUIT

The following schematic on the left-hand side shows a sample connection of a general resonator. The oscillation circuit contains a feedback resistor (1 $M\Omega$). The values of capacitors (C_1 and C_2) must be adjusted to the optimum constant of the resonator used.

The following schematic on the right-hand side shows a sample connection of a 3rd overtone resonator. The values of capacitors (C_1 , C_2 , and C_3) and inductor (L_1) must be adjusted to the optimum constant of the resonator used.

The most suitable value is different by individual resonator. Please refer to the resonator manufacturer which you use for the most suitable value.

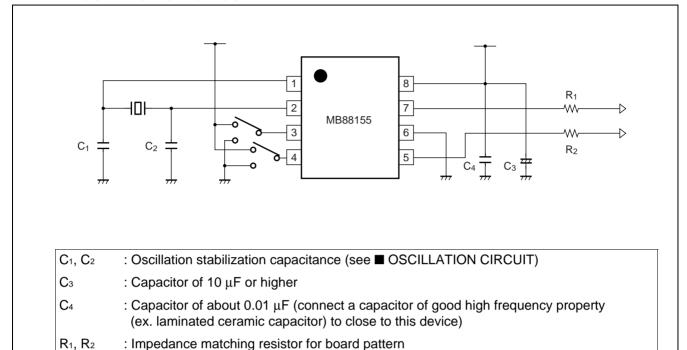
To use an external clock signal (without using the resonator), input the clock signal to the XIN pin with the XOUT pin connected to nothing.



Note: Note that the jitter characteristic of the input clock signal may affect the cycle-cycle jitter characteristic.

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■ INTERCONNECTION CIRCUIT EXAMPLE

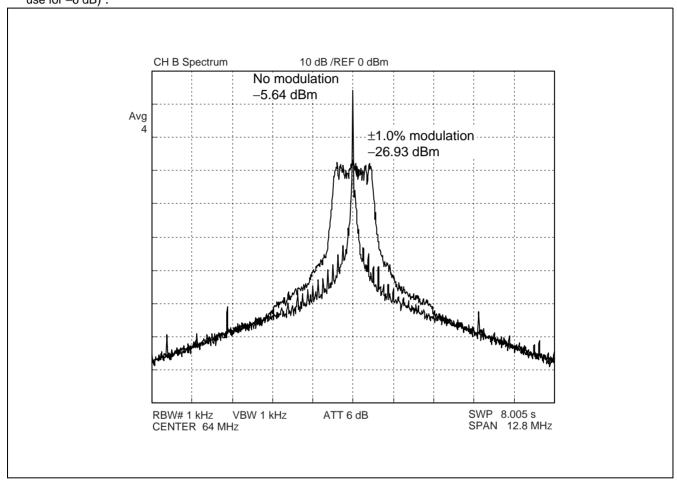


■ SPECTRUM EXAMPLE CHARACTERISTICS

The condition of the examples of the characteristic is shown as follows: Input frequency = 16 MHz (Output frequency = 64 MHz: Using MB88155-410 (Multiplied by 4))

Power-supply voltage = 3.3 V, None load capacity. Modulation rate = $\pm 1.0\%$ (center spread).

Spectrum analyzer HP4396B is connected with CKOUT. The result of the measurement with RBW = 1 kHz (ATT use for -6 dB).

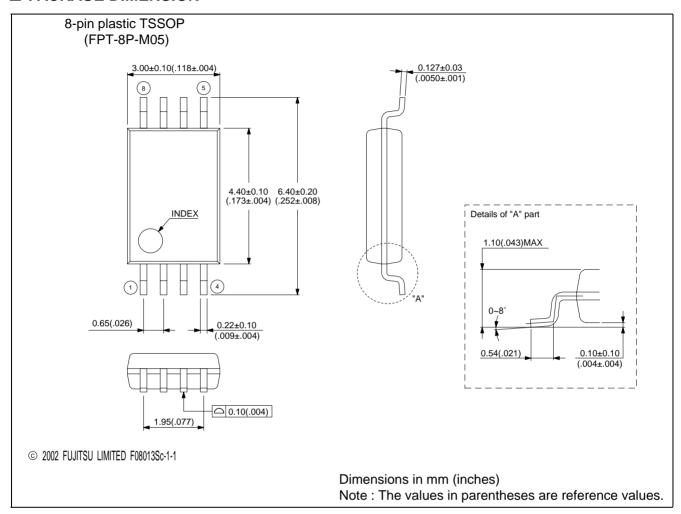


■ ORDERING INFORMATION

Part number	Input frequency	Multiplica- tion rate	Output frequency	Modulation type	Modulation enable pin	Power down pin	Package	Remarks										
MB88155PFT- G-100-BNDE1	12.5 MHz to 25 MHz				Yes	No												
MB88155PFT- G-101-BNDE1	25 MHz to 50 MHz			Down	100	110												
MB88155PFT- G-102-BNDE1	12.5 MHz to 25 MHz			spread	Ma	Vaa												
MB88155PFT- G-103-BNDE1	25 MHz to 50 MHz	Multiplied	The same		No	Yes												
MB88155PFT- G-110-BNDE1	12.5 MHz to 25 MHz	by 1	as input frequency		Yes	No												
MB88155PFT- G-111-BNDE1	25 MHz to 50 MHz			Center	res	INO	8-pin plastic											
MB88155PFT- G-112-BNDE1	12.5 MHz to 25 MHz				spread	No	Yes	TSSOP (FPT-8P-M05)										
MB88155PFT- G-113-BNDE1	25 MHz to 50 MHz								INO	162								
MB88155PFT- G-400-BNDE1		Multiplied by 4	'	Down spread	Yes	No												
MB88155PFT- G-402-BNDE1	12.5 MHz to				No	Yes												
MB88155PFT- G-410-BNDE1	20 MHz			MHz Center spread	Yes	No												
MB88155PFT- G-412-BNDE1					No	Yes												
MB88155PFT- G-100-EFE1	12.5 MHz to 25 MHz				Yes	No												
MB88155PFT- G-101-EFE1	25 MHz to 50 MHz						Down	163	NO									
MB88155PFT- G-102-EFE1	12.5 MHz to 25 MHz			spread	No	Yes												
MB88155PFT- G-103-EFE1	25 MHz to 50 MHz	Multiplied	The same as input		140	103	8-pin plastic TSSOP,	Emboss taping										
MB88155PFT- G-110-EFE1	12.5 MHz to 25 MHz	by 1	frequency		Yes	No	(FPT-8P-M05)	(EF type)										
MB88155PFT- G-111-EFE1	25 MHz to 50 MHz			Center	1 63	INU												
MB88155PFT- G-112-EFE1	12.5 MHz to 25 MHz													sprea	spread	No	Yes	
MB88155PFT- G-113-EFE1	25 MHz to 50 MHz				INU	1 62												

Part number	Input frequency	Multiplica- tion rate	Output fre- quency	Modulation type	Modulation enable pin	Power down pin	Package	Remarks
MB88155PFT- G-400-EFE1	12.5 MHz to 20 MHz	Multiplied by 4	50 MHz to 80 MHz	Down spread	Yes	No	8-pin plastic TSSOP, (FPT-8P-M05)	Emboss taping (EF type)
MB88155PFT- G-402-EFE1					No	Yes		
MB88155PFT- G-410-EFE1				Center spread	Yes	No		
MB88155PFT- G-412-EFE1					No	Yes		
MB88155PFT- G-100-ERE1	12.5 MHz to 25 MHz	Multiplied by 1	The same as input frequency	Down spread	Yes	No	8-pin plastic TSSOP (FPT-8P-M05)	Emboss taping (ER type)
MB88155PFT- G-101-ERE1	25 MHz to 50 MHz							
MB88155PFT- G-102-ERE1	12.5 MHz to 25 MHz				No	Yes		
MB88155PFT- G-103-ERE1	25 MHz to 50 MHz							
MB88155PFT- G-110-ERE1	12.5 MHz to 25 MHz			Center spread	Yes	No		
MB88155PFT- G-111-ERE1	25 MHz to 50 MHz							
MB88155PFT- G-112-ERE1	12.5 MHz to 25 MHz				No	Yes		
MB88155PFT- G-113-ERE1	25 MHz to 50 MHz							
MB88155PFT- G-400-ERE1	12.5 MHz to 20 MHz	Multiplied by 4	50 MHz to 80 MHz	Down spread	Yes	No		
MB88155PFT- G-402-ERE1					No	Yes		
MB88155PFT- G-410-ERE1				Center spread	Yes	No		
MB88155PFT- G-412-ERE1					No	Yes		

■ PACKAGE DIMENSION



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